

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or unavteries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an using of indirectly any and and plication to unavtendrized use, even if such claim any mearnet.

| ingle N | | - | | | |
|---|---|--|--|---|--------------------------|
| ieneral D | escription | | Featur | es | |
| sing Fairch | nild Semicon | OSFET has been designed ductor's advanced Power the $R_{DS(ON)} @ V_{GS} = 2.5v.$ | • 200 m | $ \begin{array}{l} A, 20 \ V R_{DS(ON)} = \ 5 \ \Omega \ \textcircled{O} \ V_G \\ \\ R_{DS(ON)} = \ 7 \ \Omega \ \textcircled{O} \ V_G \end{array} $ | |
| pplicatio | ns | V.FRER. | • ESD p | protection diode (note 3) | |
| Li-Ion Batte | ery Pack | | • RoHS | Compliant | |
| | | G | | G 1 | |
| | te Maxim | num Ratings T _{A=25°C u} | nless otherwise noted | S 2 |) 3 D |
| Absolu Symbol | | num Ratings T _{A=25°C u} Parameter | nless otherwise noted | Ratings | / Units |
| Absolu Symbol | Drain-Source | num Ratings T _{A=25°C u} Parameter ce Voltage | nless otherwise noted | Ratings 20 | / Units |
| Absolu Symbol V _{DSS} V _{GSS} | Drain-Sourc Gate-Sourc | num Ratings T _{A=25°C u} Parameter ce Voltage | | Ratings 20 ± 12 | / Units |
| Absolu Symbol | Drain-Sourc Gate-Sourc | num Ratings T _{A=25°C u} Parameter ce Voltage e Voltage | nless otherwise noted (Note 1a) 1a) | Ratings 20 | / Units |
| Absolu Symbol V _{DSS} V _{GSS} | Drain-Sourc Gate-Sourc Drain Curre | num Ratings T _{A=25°C u} Parameter ce Voltage e Voltage int – Continuous | | Ratings 20 ± 12 200 | / Units |
| Absolu Symbol V _{DSS} V _{GSS} I _D P _D | Drain-Sourc Gate-Sourc Drain Curre Power Diss | num Ratings T _{A=25°C u} Parameter ce Voltage e Voltage int – Continuous – Pulsed ipation (Steady State) | (Note 1a) 1a) (Note 1a) 1a) (Note 1b) 1 | Ratings 20 ± 12 200 1000 625 446 | / Units V MA mW |
| Absolu Symbol V _{DSS} V _{GSS} I _D P _D | Drain-Sourc Gate-Sourc Drain Curre Power Diss | num Ratings T _{A=25°C u} Parameter ce Voltage e Voltage int – Continuous – Pulsed | (Note 1a) 1a) (Note 1a) 1a) (Note 1b) 1 | Ratings 20 ± 12 200 1000 625 |) Units V V mA |
| Absolu Symbol V _{DSS} V _{GSS} I _D P _D T _J , T _{STG} | Drain-Sourc Gate-Sourc Drain Curre Power Diss Operating a Range | num Ratings T _{A=25°C u} Parameter ce Voltage e Voltage int – Continuous – Pulsed ipation (Steady State) and Storage Junction Temperat | (Note 1a) 1a) (Note 1a) 1a) (Note 1b) 1 | Ratings 20 ± 12 200 1000 625 446 | / Units V MA mW |
| Absolu Symbol V _{DSS} V _{GSS} I _D P _D T _J , T _{STG} Therma | Drain-Sourc Gate-Sourc Drain Curre Power Diss Operating a Range | num Ratings T_A=25°C u Parameter ce Voltage e Voltage e Voltage int – Continuous – Pulsed ipation (Steady State) and Storage Junction Temperate cteristics | (Note 1a) 1a) (Note 1a) 1a) (Note 1b) 1 URE | Ratings 20 ± 12 200 1000 625 446 -55 to +150 | / Units V V MA MW C |
| Absolu Symbol V _{DSS} V _{GSS} I _D P _D T _J , T _{STG} Therma R _{BJA} | Drain-Source Gate-Source Drain Curre Power Diss Operating a Range A Charace Thermal Re | num Ratings T _{A=25°C u} Parameter ce Voltage e Voltage int – Continuous – Pulsed ipation (Steady State) and Storage Junction Temperat | (Note 1a) 1a) (Note 1a) 1a) (Note 1b) 1 UIP (Note 1a) 1a) | Ratings 20 ± 12 200 1000 625 446 | / Units V MA mW |
| Absolu Symbol V _{DSS} V _{GSS} I _D PD T _J , T _{STG} Therma R _{0JA} R _{0JA} | Drain-Source Gate-Source Drain Curree Power Diss Operating a Range Al Charace Thermal Ree Thermal Ree | num Ratings T_A=25°C u Parameter Parameter ce Voltage e e Voltage e e Voltage e int – Continuous – Pulsed e ipation (Steady State) e Ind Storage Junction Temperate e eteristics e esistance, Junction-to-Ambient e esistance, Junction-to-Ambient e | (Note 1a) 1a) (Note 1a) 1a) (Note 1b) 1 Ure (Note 1a) 1a) (Note 1b) 1 1 (Note 1b) 1 | Ratings 20 ± 12 200 1000 625 446 -55 to +150 200 | / Units V V MA MW C |
| Absolu Symbol V _{DSS} V _{GSS} I _D P _D T _J , T _{STG} Therma R _{BJA} R _{BJA} Packag | Drain-Source Gate-Source Drain Curree Power Diss Operating a Range Al Charace Thermal Ree Thermal Ree | num Ratings T _{A=25°C u} Parameter Ce Voltage e Voltage e Voltage int – Continuous – Pulsed ipation (Steady State) Ind Storage Junction Temperat Exteristics Existance, Junction-to-Ambient | (Note 1a) 1a) (Note 1a) 1a) (Note 1b) 1 Ure (Note 1a) 1a) (Note 1b) 1 1 (Note 1b) 1 | Ratings 20 ± 12 200 1000 625 446 -55 to +150 200 | / Units V V MA MW C |

Downloaded from Arrow.com.

FAIRCHILD SEMICONDUCTOR®

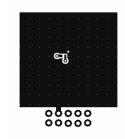
www.fairchildsemi.com

FDY301NZ Single N-Channel 2.5V Specified PowerTrench[®] MOSFET

January 2006

| Symbol | Parameter | Test Conditions | Min | Тур | Max | Units |
|--|---|---|-----|------|------------------------|----------|
| Off Char | acteristics | | | | 11 | |
| BV _{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0~V, \qquad I_{D}=250~\mu A$ | 20 | | | V |
| <u>ΔBV_{DSS}</u> ΔTj | Breakdown Voltage Temperature Coefficient | I_D = 250 µA, Referenced to 25°C | | 14 | | mV/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{\text{DS}} = 16 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$ | | | 1 | μA |
| I _{GSS} | Gate-Body Leakage, | | | | ± 10 ± 1 | μA μA |
| On Char | acteristics (Note 2) | | | • | | |
| V _{GS(th)} | Gate Threshold Voltage | $V_{DS} = V_{GS}, \qquad I_D = 250 \ \mu A$ | 0.6 | - | 1.5 | V |
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$ | Gate Threshold Voltage Temperature Coefficient | $I_D = 250 \ \mu$ A, Referenced to 25 C | | 2.8 | | mV/°C |
| R _{DS(on)} | Static Drain–Source On–Resistance | $ \begin{array}{ll} V_{GS}=4.5 \ V, & I_{D}=200 \ mA \\ V_{GS}=2.5 \ V, & I_{D}=175 \ mA \\ V_{GS}=1.8 \ V, & I_{D}=150 \ mA \\ V_{GS}=1.5 \ V, & I_{D}=20 \ mA \\ V_{GS}=4.5 \ V, \ I_{D}=200 \ mA, \ T_{J}=125^{\circ}C \end{array} $ | | | 5 7 9 10 7 | Ω |
| g FS | Forward Transconductance | $V_{DS} = 5 \text{ V}, \qquad I_D = 200 \text{ mA}$ | | 1.1 | | S |
| Dynamic | Characteristics | | | | | |
| C _{iss} | Input Capacitance | $V_{DS} = 10 \text{ V}, \qquad V_{GS} = 0 \text{ V},$ | | 60 | | pF |
| Coss | Output Capacitance | f = 1.0 MHz | | 20 | | pF |
| C _{rss} | Reverse Transfer Capacitance | | | 10 | | pF |
| Switchin | g Characteristics (Note 2) | | | | | |
| t _{d(on)} | Turn–On Delay Time | $V_{DD} = 10 V$, $I_D = 1 A$, | | 6 | 12 | ns |
| tr | Turn–On Rise Time | $V_{GS} = 4.5 \text{ V}, R_{GEN} = 6 \Omega$ | | 8 | 16 | ns |
| t _{d(off)} | Turn-Off Delay Time | | | 8 | 16 | ns |
| t _f | Turn-Off Fall Time | | | 2.4 | 4.8 | ns |
| Qg | Total Gate Charge | $V_{DS} = 10 \text{ V}, \qquad I_D = 200 \text{ mA},$ | | 0.8 | 1.1 | nC |
| Q _{gs} | Gate-Source Charge | $V_{GS} = 4.5 V$ | | 0.16 | | nC |
| Q _{gd} | Gate-Drain Charge | | | 0.26 | | nC |
| Drain-So | ource Diode Characteristics | and Maximum Ratings | | | | |
| V _{SD} | Drain–Source Diode Forward Voltage | $V_{GS} = 0 \text{ V}, I_{S} = 150 \text{ mA} \text{ (Note 2)}$ | | 0.7 | 1.2 | V |
| t _{rr} | Diode Reverse Recovery Time | I _F = 200 mA, | | 12 | | nS |
| | | dI _F /dt = 100 A/µs | | | | |

the drain pins. $\rm R_{BJC}$ is guaranteed by design while $\rm R_{BCA}$ is determined by the user's board design.



| a) | 200 °C/W when mounted on a 1 in ² pad of 2 oz copper |
|----|---|
| | |
| | |

‴ોં

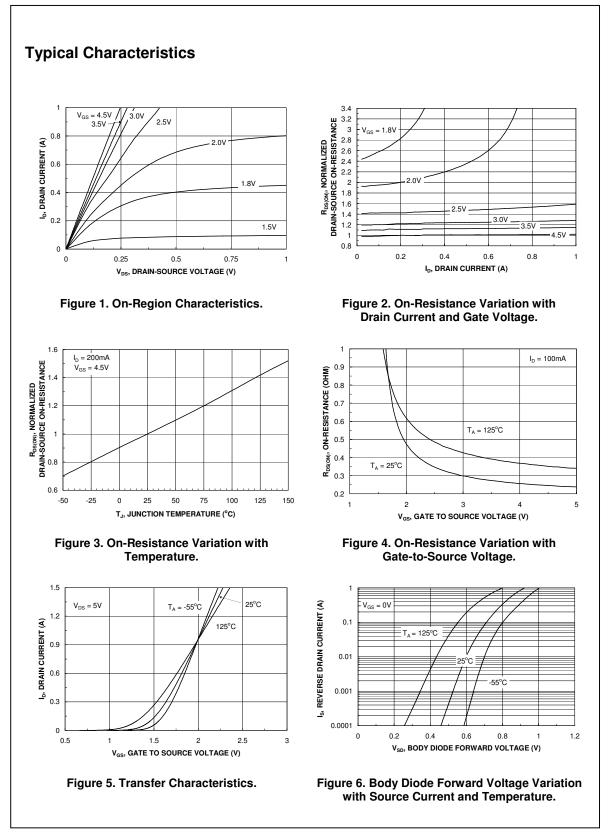
00000

b) 280 °C/W when mounted on a minimum pad of 2 oz copper Scale 1 : 1 on letter size paper

- 2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%
- The diode connected between the gate and source serves only as protection againts ESD. No gate overvoltage rating is implied.

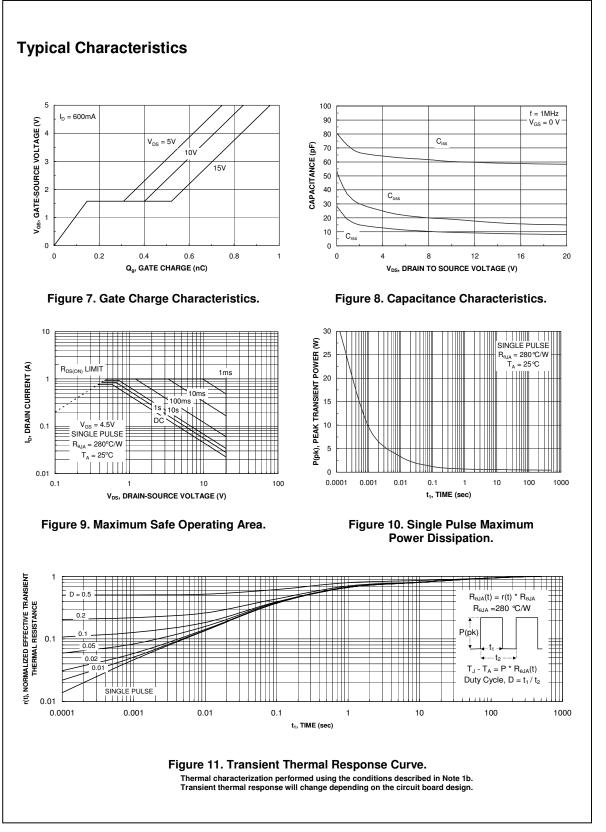
FDY301NZ Rev A

www.fairchildsemi.com

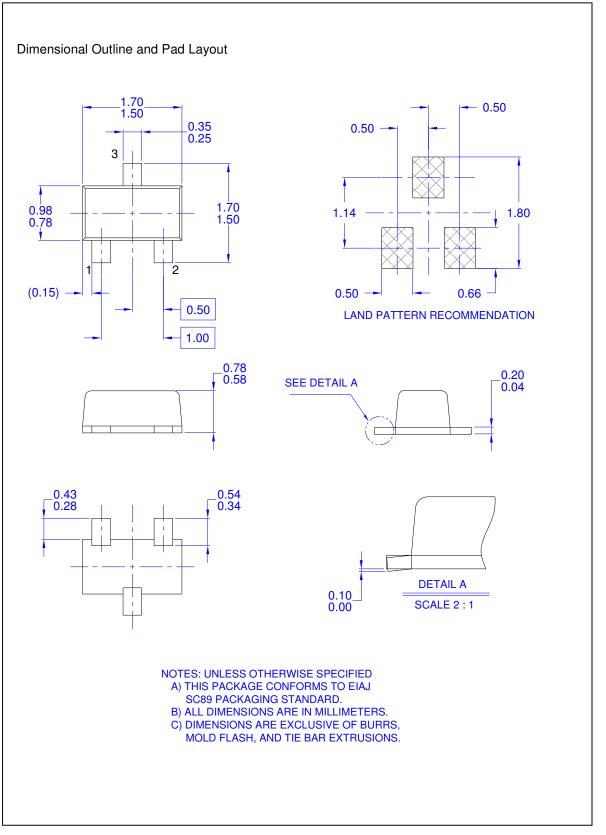


FDY301NZ Rev A

www.fairchildsemi.com



www.fairchildsemi.com



FDY301NZ Rev A

www.fairchildsemi.com

FDY301NZ Single N-Channel 2.5V Specified PowerTrench[®] MOSFET

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

| ACEx™ ActiveArray™ | FAST [®] FASTr™ | ISOPLANAR™ LittleFET™ | PowerSaver™ PowerTrench [®] | SuperSOT™-6 SuperSOT™-8 |
|-----------------------|--------------------------------|--------------------------|---|----------------------------|
| Bottomless™ | FPS™ | MICROCOUPLER™ | QFET [®] | SyncFET™ |
| Build it Now™ | FRFET™ | MicroFET™ | QS™ | TCM™ |
| CoolFET™ | GlobalOptoisolator™ | MicroPak™ | QT Optoelectronics [™] | TinyLogic [®] |
| CROSSVOLT™ | GTO™ | MICROWIRE™ | Quiet Series™ | TINYOPTO™ |
| DOME™ | HiSeC™ | MSX™ | RapidConfigure™ | TruTranslation™ |
| EcoSPARK™ | I ² C [™] | MSXPro™ | RapidConnect™ | UHC™ |
| E ² CMOS™ | <i>i-Lo</i> ™ | OCX™ | µSerDes™ | UltraFET® |
| EnSigna™ | ImpliedDisconnect [™] | OCXPro™ | ScalarPump™ | UniFET™ |
| FACT™ | IntelliMAX™ | OPTOLOGIC [®] | SILENT SWITCHER [®] | VCX™ |
| FACT Quiet Serie | ≥S [™] | OPTOPLANAR™ | SMART START™ | Wire™ |
| Across the board | l. Around the world.™ | PACMAN™ | SPM™ | |
| The Power France | | POP™ | Stealth™ | |
| Programmable A | | Power247™ | SuperFET™ | |
| Frogrammable A | | PowerEdge™ | SuperSOT™-3 | |

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

| Datasheet Identification | Product Status | Definition |
|--------------------------|---------------------------|---|
| Advance Information | Formative or In Design | This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. |
| Preliminary | First Production | This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| No Identification Needed | Full Production | This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| Obsolete | Not In Production | This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only. |
| | | Rev. 11 |

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC

Downloaded from Arrow.com.